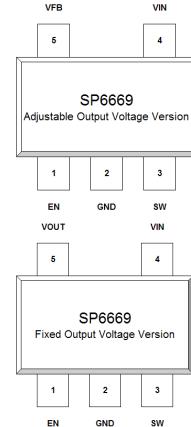


## 1.5MHZ, 600mA SYNCHRONOUS STEP DOWN CONVERTER

### FEATURES

- Up to 600mA Output Current
  - Up to 95% Efficiency
  - 1.5MHz Constant Frequency Operation
  - Low Dropout Operation Mode: 100% Duty Cycle
- Output Voltages as low as 0.6V
- No Schottky Diode Required
- 200µA Quiescent Current (no load)
- Excellent Line and Load Transient Response
- Over-Temperature Protection
- 2.5V to 5.5V Input Voltage Range
- Lead Free SOT23-5 Package



### APPLICATIONS

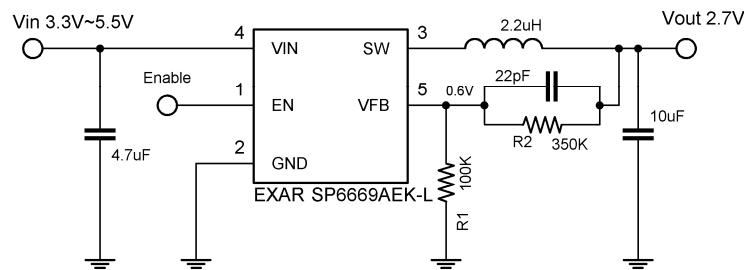
- Cellular Phones
- Wireless Networking
- Digital Cameras
- Portable Media Players
- Bluetooth Devices
- Portable Instruments



### DESCRIPTION

The SP6669 is a 600mA synchronous buck converter using a constant frequency current mode architecture with pulse width modulation (PWM) for low output voltage ripple and fixed frequency noise, a pulse skip mode (PSM) for light load efficiency and a LDO mode for 100% duty cycle. With a 2.5V to 5.5V input voltage range and a 1.5MHz switching frequency, the SP6669 allows the use of small surface mount inductors and capacitors ideal for battery powered portable applications. The internal synchronous switch increases efficiency and eliminates the need for an external Schottky diode. Low output voltages are easily supported with the 0.6V feedback reference voltage. The SP6669 is available in an adjustable output voltage version, using an external resistor divider circuit, as well as fixed output voltage versions of 1.2V, 1.5V and 1.8V. The SP6669 is available in a 5 pin SOT-23 package.

### TYPICAL APPLICATION CIRCUIT



## BLOCK DIAGRAM

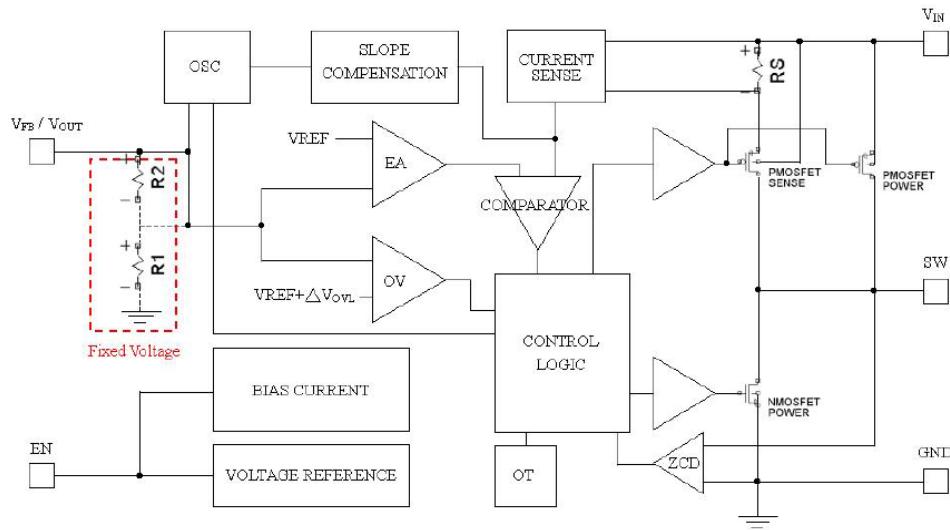
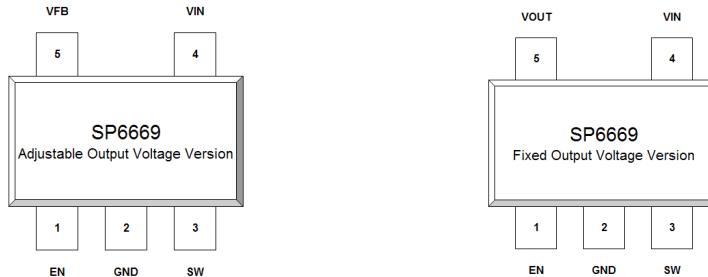


Fig.1: SP6669 Block Diagram

## PIN DESCRIPTION

### SOT23-5L



Pin Number	Name	Description
1	EN	Enable Pin. Do not leave the pin floating. $V_{EN}<0.4V$ : Shutdown mode $V_{EN}>1.2V$ : Device enabled
2	GND	Ground Signal Pin.
3	SW	Switching node.
4	VIN	Power Supply Pin. Must be decoupled to ground with a $4.7\mu F$ or greater ceramic capacitor.
5	VFB	Adjustable Version Feedback Input Pin. Connect VFB to the center point of the resistor divider.
	VOUT	Fixed Output Voltage Version, Output Voltage Pin. An internal resistive divider divides the output voltage down for comparison to the internal reference voltage.

## ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Input Voltage $V_{IN}$ .....	-0.3V to 6V	Operating Junction Temp. (Note 1).....	125°C
EN $V_{FB}$ Voltage .....	-0.3V to $V_{IN}$	Storage Temp. Range $T_{STG}$ .....	-65°C to 150°C
SW Voltage.....	-0.3V to ( $V_{IN}$ + 0.3V)	Lead Temperature (sold. 10s) $T_{LEAD}$ .....	300°C
PMOS Switch Source Current (DC) .....	800mA	Thermal Resistance	
NMOS Switch Sink Current (DC) .....	800mA	$R_{\theta JA}$ .....	250°C/W
Peak Switch Sink and Source Current .....	1.3A	$R_{\theta JC}$ .....	90°C/W

Note 1:  $T_J$  is a function of the ambient temperature  $T_A$  and power dissipation  $P_D$  ( $T_J = T_A + P_D \times 250^\circ\text{C}/\text{W}$ ).

### Recommended Operating Conditions

Operating Temperature  $T_{OP}$  ..... -40°C to 85 °C      Input voltage  $V_{IN}$ ..... 2.5V to 5.5V

$V_{IN}$ =3.6V,  $T_A$ =25°C, unless otherwise specified – Boldface characters apply over the full temperature range.

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Feedback Current	$I_{VFB}$				<b>±30</b>	nA
Regulated Feedback Voltage	$V_{FB}$	$T_A=25^\circ\text{C}$	0.588	0.600	0.612	V
Reference Voltage Line Regulation	$\Delta V_{FB}$	$V_{IN}=2.5\text{V to }5.5\text{V}$			<b>0.4</b>	%/V
Output Voltage Accuracy	$\Delta V_{OUT}\%$		<b>-3</b>		<b>+3</b>	%
Output Over-Voltage Lockout	$\Delta V_{OVL}$	$\Delta V_{OVL} = V_{OVL} - V_{FB}$ (Adj.)	20	50	80	mV
		$\Delta V_{OVL} = V_{OVL} - V_{OUT}$ (Fixed)	2.5	7.8	13	%
Output Voltage Line Regulation	$\Delta V_{OUT}$	$V_{IN}=2.5\text{V to }5.5\text{V}$			<b>0.4</b>	%/V
Peak Inductor Current	$I_{PK}$	$V_{IN}=3\text{V}, V_{FB}=0.5\text{V}$ or $V_{OUT}=90\%$ , Duty cycle <35%		1.0		A
Output Voltage Load Regulation	$V_{LOADREG}$			0.5		%
Quiescent Current (Note 2)	$I_Q$	$V_{FB}=0.5\text{V}$ or $V_{OUT}=90\%$		200	340	µA
Shutdown Current	$I_{SHUTDOWN}$	$V_{EN}=0\text{V}, V_{IN}=4.2\text{V}$		0.1	1	µA
Oscillator Frequency	$f_{osc}$	$V_{FB}=0.6\text{V}$ or $V_{OUT}=100\%$	<b>1.2</b>	<b>1.5</b>	<b>1.8</b>	MHz
		$V_{FB}=0\text{V}$ or $V_{OUT}=0\text{V}$		<b>290</b>		kHz
$R_{DS(ON)}$ of PMOS	$R_{PFET}$	$I_{SW}=100\text{mA}$		0.45	0.55	Ω
$R_{DS(ON)}$ of NMOS	$R_{NFET}$	$I_{SW}=100\text{mA}$		0.40	0.50	Ω
SW Leakage	$I_{LSW}$	$V_{EN}=0\text{V}, V_{SW}=0\text{V}$ or 5V, $V_{IN}=5\text{V}$			<b>±1</b>	µA
Enable Threshold	$V_{EN}$				<b>1.2</b>	V
Shutdown Threshold			<b>0.4</b>			V
EN Leakage Current	$I_{EN}$				<b>±1</b>	µA

Note 1: The Switch Current Limit is related to the Duty Cycle. Please refer to figure 15 for details.

Note 2: Dynamic quiescent current is higher due to the gate charge being delivered at the switching frequency.

## ELECTRICAL CHARACTERISTICS

### Typical Characteristics

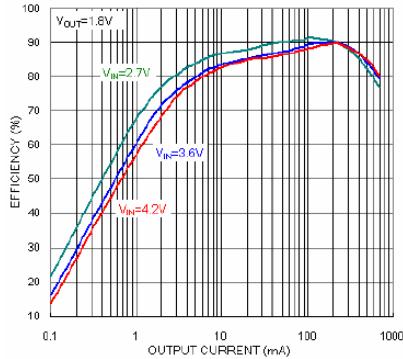


Fig. 2: Efficiency vs Output Current (mA)

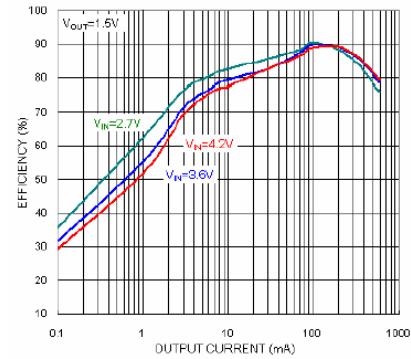


Fig. 3: Efficiency vs Output Current (mA)

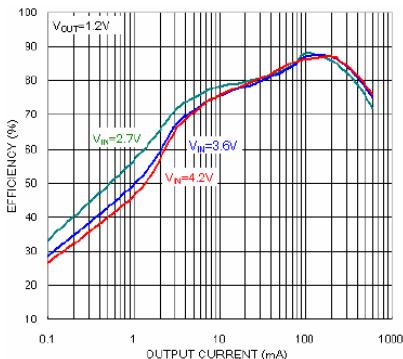


Fig. 4: Efficiency vs Output Current (mA)

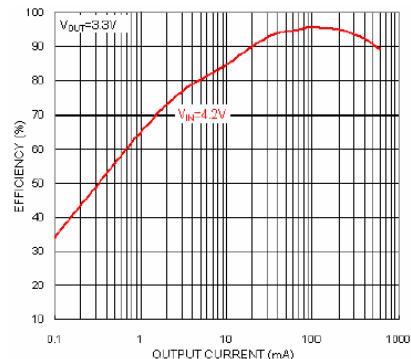


Fig. 5: Efficiency vs Output Current (mA)

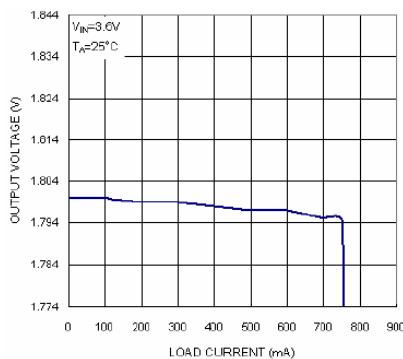


Fig. 6: Output Voltage vs Load Current

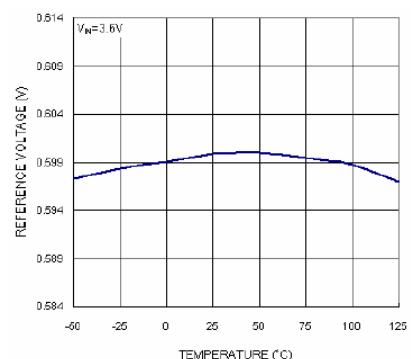


Fig. 7: Reference Voltage vs Temperature

## ELECTRICAL CHARACTERISTICS

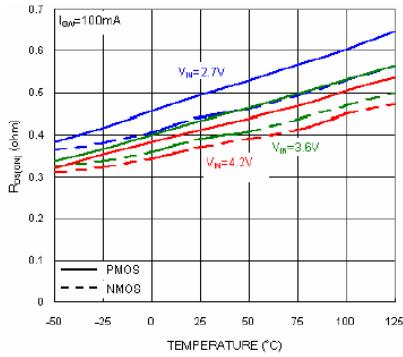


Fig. 8:  $R_{DS(ON)}$  vs Temperature

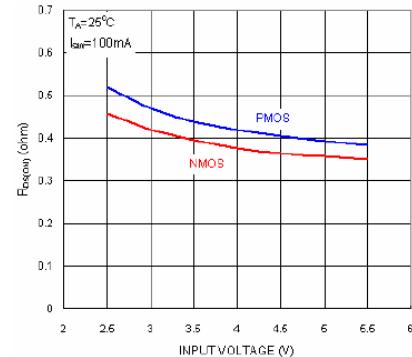


Fig. 9:  $R_{DS(ON)}$  vs Input Voltage

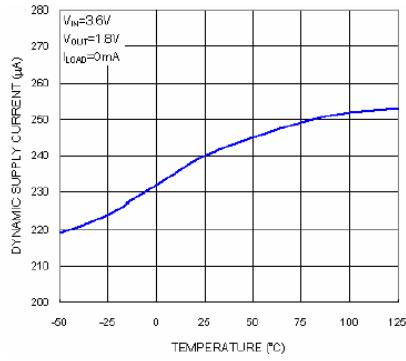


Fig. 10: Dynamic Supply Current vs Temperature

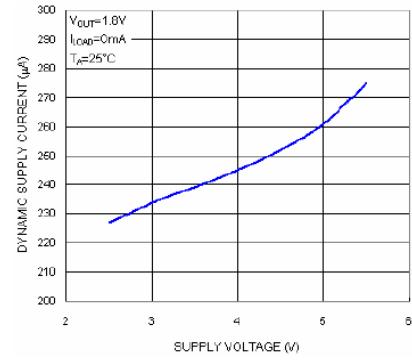


Fig. 11: Dynamic Supply Current vs Supply Voltage

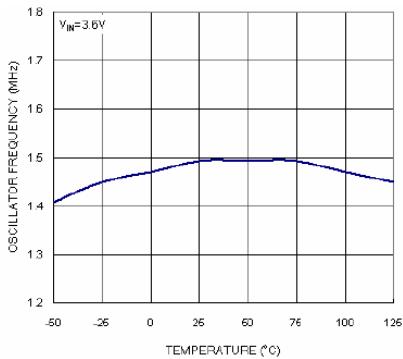


Fig. 12: Oscillator Frequency vs Temperature

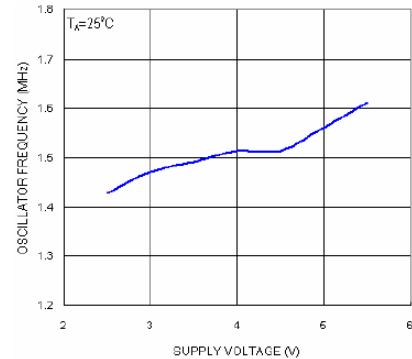


Fig. 13: Oscillator Frequency vs Supply Voltage

## ELECTRICAL CHARACTERISTICS

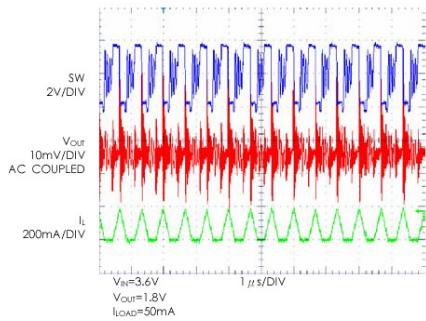


Fig. 14: Discontinuous Operation

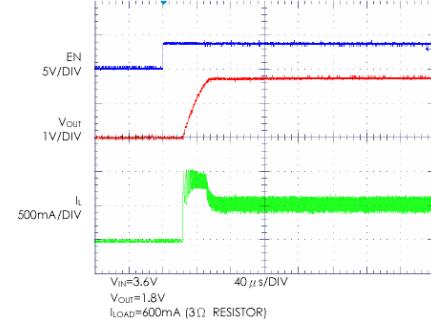


Fig. 15: Start-up from Shutdown

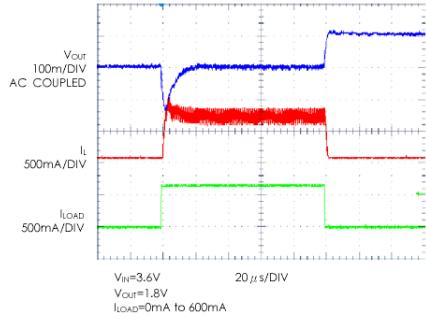


Fig. 16: Load Step

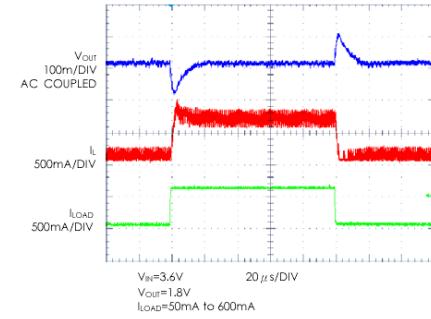


Fig. 17: Load Step

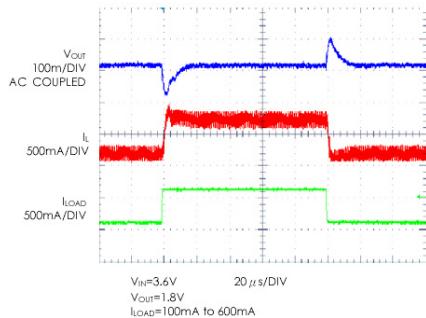


Fig. 17: Load Step

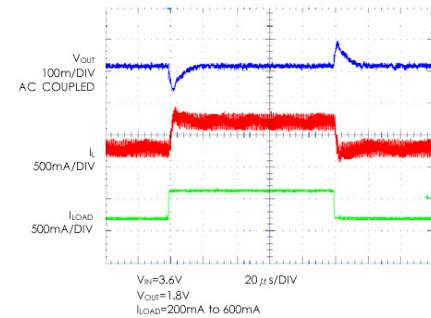


Fig. 18: Load Step

### Detailed Description

#### Applications

The typical application circuit of the adjustable output voltage option and the fixed output voltage option are shown below.

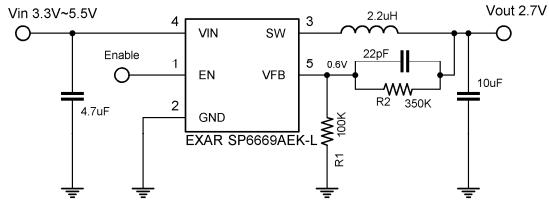


Fig. 18: Adjustable Output Voltage Version  
Typical Application Circuit

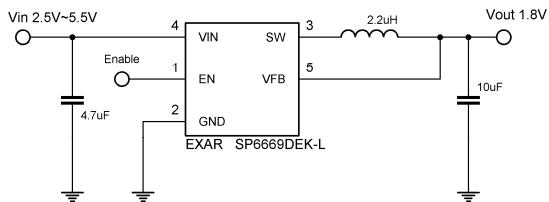


Fig. 19: Fixed Output Voltage Version  
Typical Application Circuit

#### Inductor Selection

Inductor ripple current and core saturation are two factors considered to select the inductor value.

$$\text{Eq. 1: } \Delta I_L = \frac{1}{f \cdot L} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Equation 1 shows the inductor ripple current as a function of the frequency, inductance,  $V_{IN}$  and  $V_{OUT}$ . It is recommended to set the ripple current to 40% of the maximum load current. A low ESR inductor is preferred.

#### $C_{IN}$ and $C_{OUT}$ Selection

A low ESR input capacitor can prevent large voltage transients at  $V_{IN}$ . The RMS current rating of the input capacitor is required to be larger than  $I_{RMS}$  calculated by:

$$\text{Eq. 2: } I_{RMS} \cong I_{OMAX} \frac{\sqrt{V_{OUT}(V_{IN} - V_{OUT})}}{V_{IN}}$$

The ESR rating of the capacitor is an important parameter to select  $C_{OUT}$ . The output ripple  $V_{OUT}$  is determined by:

$$\text{Eq. 3: } \Delta V_{OUT} \cong \Delta I_L \left( ESR + \frac{1}{8 \cdot f \cdot C_{OUT}} \right)$$

Higher values, lower cost ceramic capacitors are now available in smaller sizes. These capacitors have high ripple currents, high voltage ratings and low ESR that makes them ideal for switching regulator applications. As  $C_{OUT}$  does not affect the internal control loop stability, its value can be optimized to balance very low output ripple and circuit size. It is recommended to use an X5R or X7R rated capacitors which have the best temperature and voltage characteristics of all the ceramics for a given value and size.

#### Output Voltage – Adjustable Version

The adjustable output voltage version is determined by:

$$\text{Eq. 4: } V_{OUT} = 0.6V \cdot \left( 1 + \frac{R_2}{R_1} \right)$$

#### Thermal Considerations

Although the SP6669 has an on board over temperature circuitry, the total power dissipation it can support is based on the package thermal capabilities. The formula to ensure safe operation is given in note 1.

#### PCB Layout

The following PCB layout guidelines should be taken into account to ensure proper operation and performance of the SP6669:

- 1- The GND, SW and  $V_{IN}$  traces should be kept short, direct and wide.
- 2-  $V_{FB}$  pin must be connected directly to the feedback resistors. The resistor divider network must be connected in parallel to the  $C_{OUT}$  capacitor.
- 3- The input capacitor  $C_{IN}$  must be kept as close as possible to the  $V_{IN}$  pin.

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## THEORY OF OPERATION

- 4- The SW and VFB nodes should be kept as separate as possible to minimize possible effects from the high frequency and voltage swings of the SW node.
- 5- The ground plates of  $C_{IN}$  and  $C_{OUT}$  should be kept as close as possible.

### Output Voltage Ripple for $V_{IN}$ close to $V_{OUT}$

When the input voltage  $V_{IN}$  is close to the output voltage  $V_{OUT}$ , the SP6669 transitions smoothly from the switching PWM converter mode into a LDO mode. The following diagram shows the output voltage ripple versus the input voltage for a 3.3V output setting and a 200mA current load.

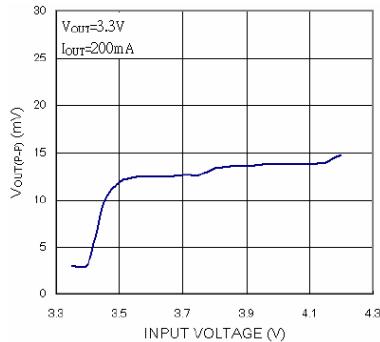


Fig.20:  $V_{OUT}$  Ripple Voltage for  $V_{IN}$  decreasing close to  $V_{OUT}$

### Design Example

In a single Lithium-Ion battery powered application, the  $V_{IN}$  range is about 2.7V to 4.2V. The desired output voltage is 1.8V.

The inductor value needed can be calculated using the following equation

$$L = \frac{1}{f \cdot \Delta I_L} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

Substituting  $V_{OUT}=1.8V$ ,  $V_{IN}=4.2V$ ,  $\Delta I_L=240mA$  and  $f=1.5MHz$  gives

$$L = 2.86\mu H$$

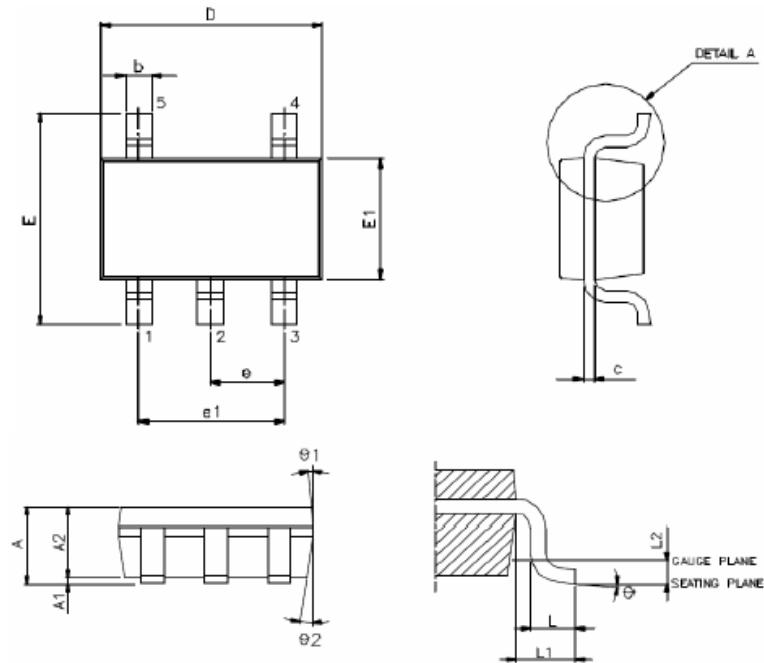
A 2.2 $\mu$ H inductor can be chosen with this application. An inductor of greater value with less equivalent series resistance would provide better efficiency. The  $C_{IN}$  capacitor requires an RMS current rating of at least  $I_{LOAD(MAX)}/2$  and low ESR. In most cases, a ceramic capacitor will satisfy this requirement.

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## PACKAGE

### SOT23-5L

Unit: mm



VARIATION(ALL DIMENSIONS SHOWN IN MM)

SYMBOL	MIN.	NOM.	MAX.
A	1.05	1.20	1.35
A1	0.05	0.10	0.15
A2	1.00	1.10	1.20
b	0.30	—	0.50
c	0.08	—	0.20
D	2.80	2.90	3.00
E	2.60	2.80	3.00
E1	1.50	1.60	1.70
e	0.95 BSC.		
e1		1.90 BSC.	
L	0.30	0.45	0.55
L1	0.60	REF.	
L2		0.25 BSC.	
θ	0°	5°	10°
θ1	3°	5°	7°
θ2	6°	8°	10°

NOTE : 1.JEDEC OUTLINE : MO-178 AA

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## ORDERING INFORMATION

### Adjustable Output Voltage Version

Part Number	Voltage Option	Operating Temperature Range	Package	Marking	Packing Quantity
SP6669AEK-L/TRR3	Adjustable	-40°C to +85°C	SOT23-5	QBWW	3,000/T&R

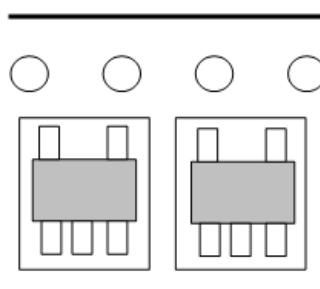
"WW" = Work Week

### Fixed Output Voltage Version

Part Number	Voltage Option	Operating Temperature Range	Package	Marking	Packing Quantity
SP6669BEK-L/TRR3	1.2V	-40°C to +85°C	SOT23-5	RBWW	3,000/T&R
SP6669CEK-L/TRR3	1.5V	-40°C to +85°C	SOT23-5	SBWW	3,000/T&R
SP6669DEK-L/TRR3	1.8V	-40°C to +85°C	SOT23-5	TBWW	3,000/T&R

"WW" = Work Week

Note that the SP6669 series is packaged in Tape and Reel with a reverse part orientation as per the following diagram



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### Exar Corporation Headquarters and Sales Offices

48720 Kato Road  
Fremont, CA 94538 – USA  
Tel.: +1 (510) 668-7000  
Fax: +1 (510) 668-7030  
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